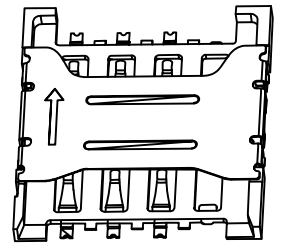
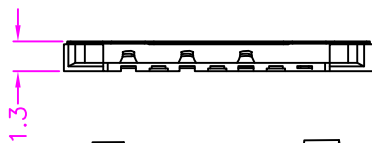


P.C.B. LAYOUT  
TOP VIEW ±0.05

- KEEP AREA
- KEEP OUT AREA
- PAD AREA
- PCB THROUGH HOLE



**MATERIALS**

HOUSING: HI-TEMP. PLASTIC (UL 94V-0)  
 SHELL: SUS  
 SOLDER PAD: SUS, GOLD PLATING  
 TERMINAL: COPPER ALLOY, GOLD PLATED ON CONTACT AREA  
 TIN PLATING ON SOLDER TAIL

**SPECIFICATION**

CURRENT RATING: 0.5 AMP MAX  
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE  
 CONTACT RESISTANCE: 100m OHMS MAX  
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V  
 OPERATION TEMPERATURE: -40°C~+85°C

PIN NO.	DESCRIPTION
C1	VCC (SUPPLY VOLTAGE)
C2	RST (RESET SIGNAL)
C3	CLK (CLOCK SIGNAL)
C5	GND
C6	VPP (VARIABLE SUPPLY VLOTAGE)
C7	I/O (DATA INPUT/OUTPUT)

**PART NUMBER:**

MMCQB - 0 6 \* T - 1 2 4



**CONTACT PLATED OPTION**

- 1: GOLD FLASH
- 3: 3u" GOLD
- 5: 5u" GOLD
- 6: 10u" GOLD
- 7: 15u" GOLD
- 9: 30u" GOLD



**TOLERANCES**

X.±0.40	.XX±0.20
.X±0.30	.XXX±0.10

REV.	A

DRAWN BY	Zhong 2018/8/22
APPROVED BY	Lion 2018/8/22

TITLE	MICRO SIM CARD, 6PIN, PCB MOUNT, SMT, METAL SHIELD, H=1.30mm, FEMALE				
DRAW NO.	MMCQB-001	UNIT	MM	Sheet	1/1